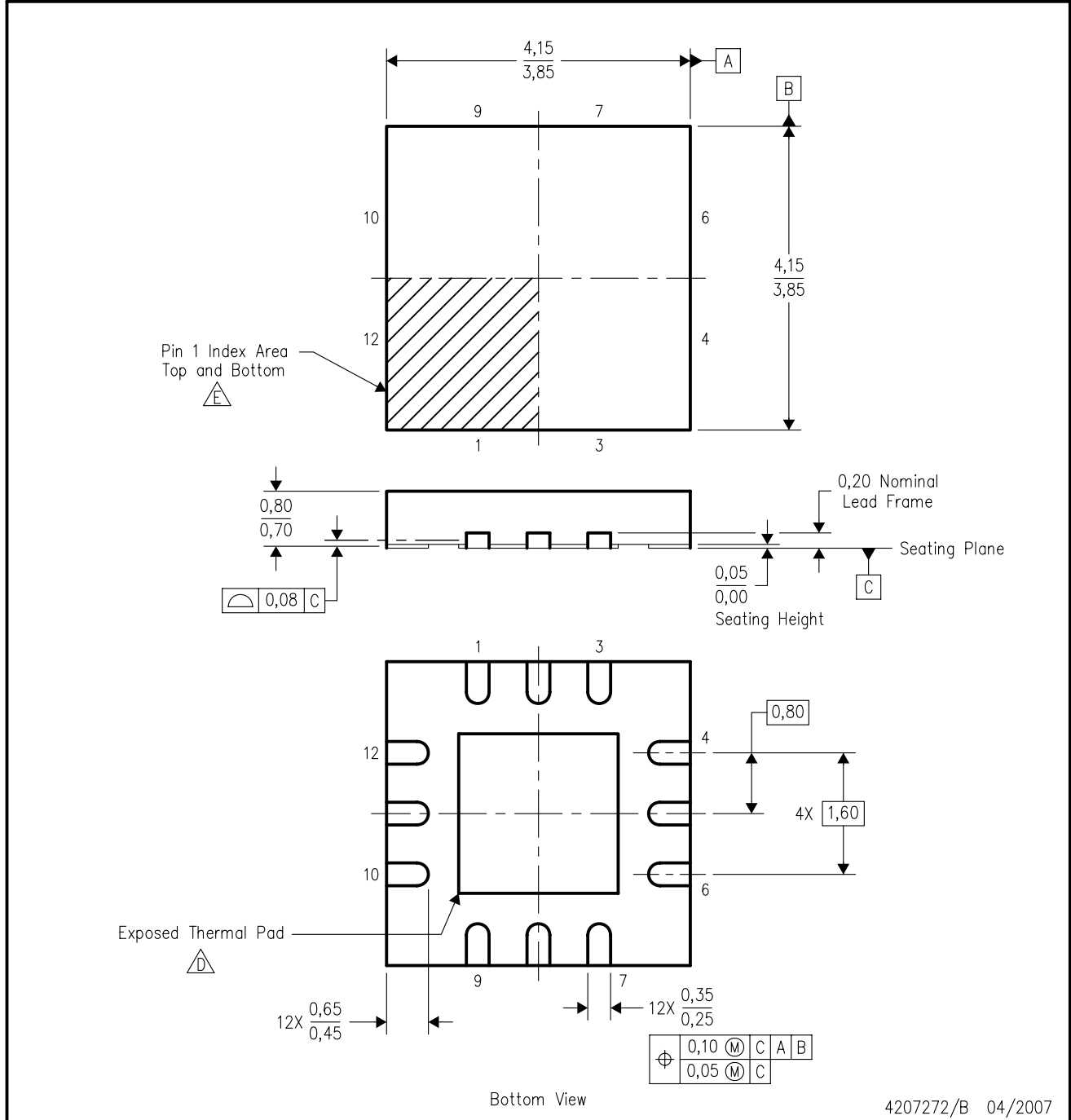


RSF (S-PQFP-N12)

PLASTIC QUAD FLATPACK



4207272/B 04/2007

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. QFN (Quad Flatpack No-Lead) package configuration.
  - The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.
  - Pin 1 identifiers are located on both top and bottom of the package and within the zone indicated. The Pin 1 identifiers are either a molded, marked, or metal feature.
  - F. Complies to JEDEC MO-220 variation WGGB.

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Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265  
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